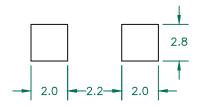
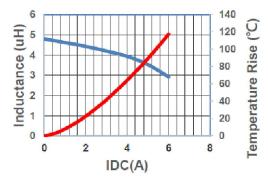
MGV05024R7M-12

PHYSICAL DIMENSIONS:

A 5.50 ± 0.50 B 5.10 ± 0.30 C 2.00 ± 0.40 D 2.50 ± 0.30 E 1.10 ± 0.30

LAND PATTERNS FOR REFLOW SOLDERING

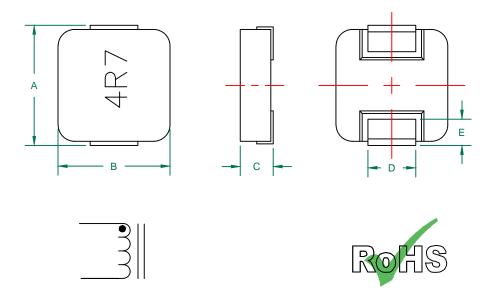




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max	
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	3.76	4.70	5.64	
DCR (Ω)			0.1166	

Saturation Current ³ Isat (A)	5.00
Temperature Rise Current Irms ⁴(A)	2.80



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. OPERATION TEMPERATURE RANGE:
 -55°C~+125°C (INCLUDING SELF-HEATING) .
- 3. SATURATION CURRENT Is at IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY APPROXIMATELY VALUE OF 30% OF INITIAL INDUCTANCE ($Ta=25\pm5^{\circ}C$).
- 4. DEFINITION OF TEMPERATURE RISE CURRENT (IRMS):

 DC CURRENT THAT CAUSES THE TEMPERATURE RISE (△T APPROXIMATELY 40°C) FROM 25°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird Tech. and is loaned in confidence subject to return upon request ar with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are	nd 📗	Laird		
				reserved. PROJECT/PART NUMBER:		PART TY	PE: WER	DRAWN BY:
				MGV05024R7M-12	AI E.	INDU	CTOR SHEET:	Jonson
Α	ORIGINAL DRAFT	08/17/18	QIU	O8/17/18	N OL #	TS		
REV	DESCRIPTION	DATE	INT	MGV05024R7M-12-A	.02 #	-	1	of 1